

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUNG-CHIH TSAI	09/07/2010
JIA-HUNG SU	09/07/2010
KAI SHIH	09/07/2010
RECEIVING PARTY DATA	
Name:	CHENG UEI PRECISION INDUSTRY CO., LTD.
Street Address:	NO. 18 CHUNG SHAN ROAD, TU-CHENG INDUSTRY PARK
City:	TU-CHENG CITY, TAIPEI HSIEN
State/Country:	TAIWAN
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29369682
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Total Attachments: 1 source=AM-2100902-Assignment#page1.tif	

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the following inventor(s) (hereinafter as "ASSIGNOR")

- 1. Name YUNG-CHIH TSAI
Residing at No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
- 2. Name JIA-HUNG SU
Residing at No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.
- 3. Name KAI SHIH
Residing at No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.

hereby sells, assigns, transfers, and sets over to CHENG UEI PRECISION INDUSTRY CO., LTD.

whose post office address is of No. 18, Chung Shan Rd., Tu-Cheng Industry Park, Tu-Cheng City, Taipei Hsien, 236, Taiwan, R.O.C.

(hereinafter as "ASSIGNEE"), its successors and assigns, the entire right, title and interest in and to the invention known as MOUNTING FRAME FOR PRINTED CIRCUIT BOARD OF A MOUSE (hereinafter as "INVENTION"), for which a United States Patent Application was executed concurrently herewith or, if not so executed, was:

- a. executed on:
- b. filed on: Application Serial No.:
- c. established by PCT International Patent Application No.:

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

The ASSIGNOR hereby agrees without charge to said ASSIGNEE but at its expense to execute all necessary papers to be used in connection with the above-identified application and any additional, substitute, continuing, divisional, reexamination, or reissue applications, as the ASSIGNEE may deem necessary or expedient; to execute all papers in connection with any interference or other legal or quasi-legal proceedings relating to the above-identified application or any additional, substitute, continuing, divisional, reexamination, reissue applications thereof; to cooperate with the ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said INVENTION.

The ASSIGNOR hereby agrees to communicate to the ASSIGNEE, or its representatives, any facts known to the ASSIGNOR respecting said INVENTION, and testify in any legal proceedings, sign all lawful papers, execute all necessary assignment papers to cause any and all Letters Patent to be issued to the ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid the ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said INVENTION.

The ASSIGNOR hereby authorizes and requests the Commissioner of the United States Patent and Trademark Office to issue any and all Letters Patent that may be granted upon any patent application for the INVENTION or any additional, substitute, continuing, or divisional applications thereof to the ASSIGNEE, its successors and assigns.

The ASSIGNOR hereby covenants and warrants that the ASSIGNOR has full right to convey the entire right, title and interest in and to said INVENTION by this assignment, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

Signature of Inventor 1	<u>Yung Chih, Tsai</u>	Executed Date	<u>Sep. 7, 2010</u>
Signature of Inventor 2	<u>Jia Hung Su</u>	Executed Date	<u>Sep. 7, 2010</u>
Signature of Inventor 3	<u>Kai Shih</u>	Executed Date	<u>Sep. 7, 2010</u>

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